



60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
00)/	13mΩ @ V _{GS} = 10V	10.3A
60V	18mΩ @ $V_{GS} = 4.5V$	8.8A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Motor control
- DC to DC converters
- · Reverse polarity protection

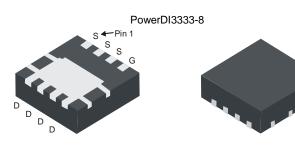
Features and Benefits

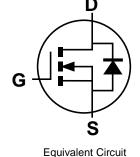
- Low R_{DS(ON)} Ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN6013LFGQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (©3)
- Weight: 0.072 grams (Approximate)





Ordering Information (Note 4)

Bottom View

Orderable Part Number	Pankago	Packing			
Orderable Fart Number	Package	Quantity	Carrier		
DMN6013LFGQ-7	PowerDI3333-8	2,000	Tape & Reel		
DMN6013LFGQ-13	PowerDI3333-8	3,000	Tape & Reel		

Top View

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site1



N63 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 23 = 2023) WW = Week Code (01 to 53)

Site2:



N63 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 3 = 2023) W = Week (ex: a = Week 27, z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	3	4	5	6	7	8	9	0	1	2	3	4
Week 1-26				27-52			53					
Code	A-Z			A-Z a-z						Z		
Internal Code	Sı	ın	Mor	1	Tue	1	Wed	Thu		Fri		Sat
Code		-	U		V		W	Х		Υ		Z

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	60	V	
Gate-Source Voltage	V _{GSS}	±20	V	
Continuous Durin Courset (Nata C) V 40V	T _A = +25°C T _A = +70°C	I _D	10.3 8.3	А
Continuous Drain Current (Note 6) V _{GS} = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I _D	45 28	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	58.3	Α
Maximum Continuous Body Diode Forward Current (Note 6)	Is	3	Α	
Avalanche Current, L = 0.1mH	I _{AS}	33.3	А	
Avalanche Energy, L = 0.1mH	E _{AS}	56.8	mJ	

Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	123	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{ hetaJA}$	69	
Total Power Dissipation (Note 6)		P_{D}	2.1	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ hetaJA}$	60	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t < 10s		34	C/VV
Total Power Dissipation (Note 6)		P_{D}	40	W
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	3.2	°C/W	
Operating and Storage Temperature Range	T_{J} , T_{STG}	-55 to +150	°C	

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.



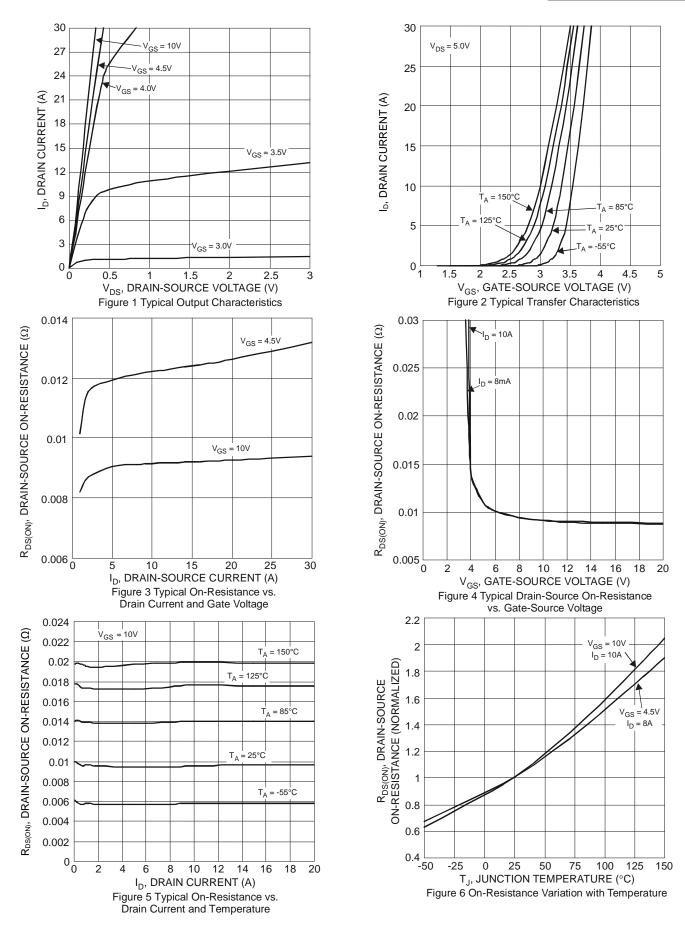
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}	_	_	1	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1	1.8	3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		_	9.3	13	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Diain-Source On-Nesistance	R _{DS(ON)}	_	12.3	18	11122	$V_{GS} = 4.5V, I_D = 8A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1.7A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	2577		pF	V 20V V 0V	
Output Capacitance	Coss	_	162	_	pF	$V_{DS} = 30V, V_{GS} = 0V,$ -f = 1MHz	
Reverse Transfer Capacitance	C _{rss}	_	132	_	pF	1 = 1101112	
Gate Resistance	Rg	_	0.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	26.6	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	55.4	_	nC), 20V, I 40A	
Gate-Source Charge	Q_{gs}	_	9.3	_	nC	$V_{DS} = 30V, I_{D} = 10A$	
Gate-Drain Charge	Q_{gd}	_	12.6	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	6.2	_	ns		
Turn-On Rise Time	t _R	_	9.9	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	27.6		ns	$R_G = 3\Omega$, $I_D = 10A$	
Turn-Off Fall Time	t _F	_	11.7	_	ns]	
Body Diode Reverse Recovery Time	t _{RR}		9.4	_	ns	I= - 100 di/dt - 1000/us	
Body Diode Reverse Recovery Charge	Q_{RR}	_	18.6	_	nC	I _F = 10A, di/dt = 100A/μs	

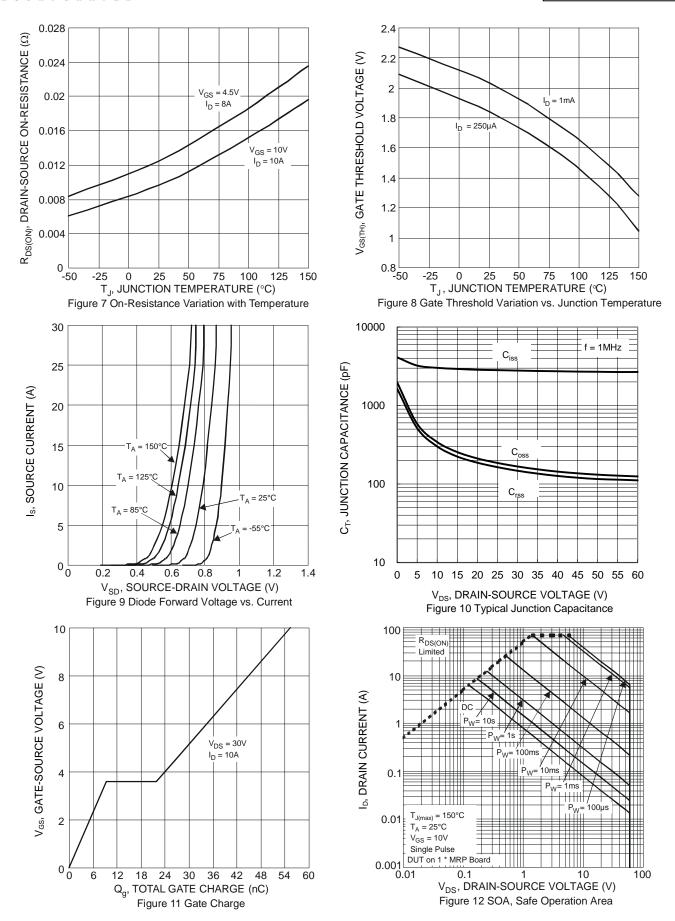
Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

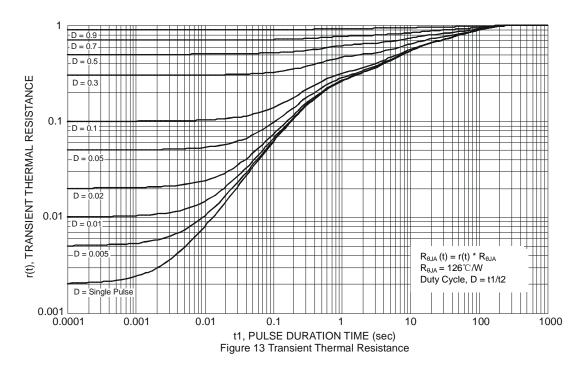










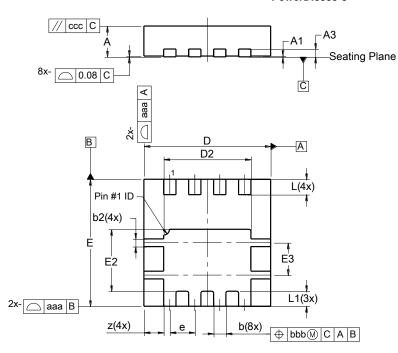




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

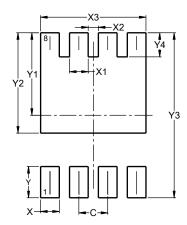


PowerDI3333-8							
Dim	Min	Max	Тур				
Α	0.75	0.85	0.80				
A1	0.00	0.05	0.02				
А3	_	_	0.203				
b	0.27	0.37	0.32				
b2	_	_	0.20				
D	3.25	3.35	3.30				
D2	2.22	2.32	2.27				
Е	3.25	3.35	3.30				
E2	1.56	1.66	1.61				
E3	0.79	0.89	0.84				
е	_	_	0.65				
L	0.35	0.45	0.40				
L1	-	_	0.39				
z	0.515						
aaa	0.25						
bbb	0.10						
CCC	0.10						
All I	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
C	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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